# 3.3V / 5V ECL Differential Receiver/Driver With Reduced Output Swing

The MC100EP16F is a differential receiver/driver. The device is functionally equivalent to the EP16 device with higher performance capabilities. With reduced output swings, rise/fall transition times are significantly faster than on the EP16. The EP16F is ideally suited for interfacing with high frequency sources.

The  $V_{BB}$  pin, an internally generated voltage supply, is available to this device only. For single–ended input conditions, the unused differential input is connected to  $V_{BB}$  as a switching reference voltage.  $V_{BB}$  may also rebias AC coupled inputs. When used, decouple  $V_{BB}$  and  $V_{CC}$  via a 0.01  $\mu F$  capacitor and limit current sourcing or sinking to 0.5 mA. When not used,  $V_{BB}$  should be left open.

- 100 ps Typical Rise and Fall Time
- Max Frequency >4 GHz Typical
- The 100 Series Contains Temperature Compensation
- PECL Mode Operating Range: V<sub>CC</sub> = 3.0 V to 5.5 V with V<sub>EE</sub> = 0 V
- NECL Mode Operating Range: V<sub>CC</sub> = 0V with V<sub>EE</sub> = -3.0 V to -5.5 V
- Open Input Default State
- Safety Clamp on Inputs



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MARKING DIAGRAMS\*



SO-8 D SUFFIX CASE 751





TSSOP-8 DT SUFFIX CASE 948R



A = Assembly Location

L = Wafer Lot

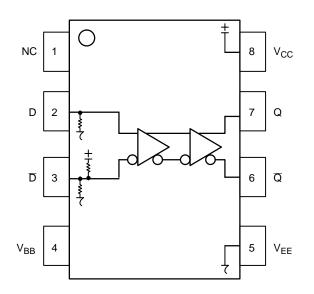
Y = Year

W = Work Week

\*For additional information, see Application Note AND8002/D

#### **ORDERING INFORMATION**

Device	Package	Shipping
MC100EP16FD	SO-8	98 Units/Rail
MC100EP16FDR2	SO-8	2500 Tape & Reel
MC100EP16FDT	TSSOP-8	100 Units/Rail
MC100EP16FDTR2	TSSOP-8	2500 Tape & Reel



## **PIN DESCRIPTION**

PIN	FUNCTION
D*, <del>D</del> **	ECL Data Inputs
Q, Q	ECL Data Outputs
$V_{BB}$	Reference Voltage Output
V <sub>CC</sub>	Positive Supply
V <sub>EE</sub>	Negative Supply
NC	No Connect

<sup>\*</sup> Pins will default LOW when left open.

Figure 1. 8-Lead Pinout (Top View) and Logic Diagram

## **ATTRIBUTES**

Characteri	Value	
Internal Input Pulldown Resistor	75 kΩ	
Internal Input Pullup Resistor		37.5 kΩ
ESD Protection	Human Body Model Machine Model Charged Device Model	> 4 kV > 200 V > 2 kV
Moisture Sensitivity, Indefinite Time	Out of Drypack (Note 1.)	Level 1
Flammability Rating Oxygen Index		UL-94 code V-0 A 1/8" 28 to 34
Transistor Count		139
Meets or exceeds JEDEC Spec EIA	/JESD78 IC Latchup Test	

<sup>1.</sup> For additional information, see Application Note AND8003/D.

## MAXIMUM RATINGS (Note 2.)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V <sub>CC</sub>	PECL Mode Power Supply	V <sub>EE</sub> = 0 V		6	V
V <sub>EE</sub>	NECL Mode Power Supply	V <sub>CC</sub> = 0 V		-6	V
V <sub>I</sub>	PECL Mode Input Voltage	V <sub>EE</sub> = 0 V	$V_{I} \leq V_{CC}$	6	V
	NECL Mode Input Voltage	$V_{CC} = 0 V$	$V_I \ge V_{EE}$	-6	V
l <sub>out</sub>	Output Current	Continuous Surge		50 100	mA mA
I <sub>BB</sub>	V <sub>BB</sub> Sink/Source			± 0.5	mA
TA	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	8 SOIC 8 SOIC	190 130	°C/W
$\theta_{\sf JC}$	Thermal Resistance (Junction to Case)	std bd	8 SOIC	41 to 44 ± 5%	°C/W
$\theta_{JA}$	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	8 TSSOP 8 TSSOP	185 140	°C/W
$\theta_{JC}$	Thermal Resistance (Junction to Case)	std bd	8 TSSOP	41 to 44 ± 5%	°C/W
T <sub>sol</sub>	Wave Solder	<2 to 3 sec @ 248°C		265	°C

 $<sup>\ \, \</sup>hbox{$2$.} \ \, \hbox{Maximum Ratings are those values beyond which device damage may occur.}$ 

 $<sup>^{\</sup>star\star}\,$  Pins will default to  $V_{CC}/2$  when left open.

## DC CHARACTERISTICS, PECL $V_{CC} = 3.3 \text{ V}$ , $V_{EE} = 0 \text{ V}$ (Note 3.)

				–40°C			25°C			85°C		
Symbol	Characteristic		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
IEE	Power Supply Current		23	28	35	25	31	38	26	33	40	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 4.)		2155	2280	2405	2155	2280	2405	2155	2280	2405	mV
V <sub>OL</sub>	Output LOW Voltage (Note 4.)		1575	1690	1775	1575	1690	1775	1575	1690	1775	mV
V <sub>IH</sub>	Input HIGH Voltage (Single Ended)		2075		2420	2075		2420	2075		2420	mV
V <sub>IL</sub>	Input LOW Voltage (Single Ended) (Note 5.)		1490		1675	1490		1675	1490		1675	mV
V <sub>BB</sub>	Output Voltage Reference		1775	1875	1975	1775	1875	1975	1775	1875	1975	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential) (Note 6.)		2.0		3.3	2.0		3.3	2.0		3.3	V
I <sub>IH</sub>	Input HIGH Current				150			150			150	μΑ
I <sub>IL</sub>		D D	0.5 -150			0.5 -150			0.5 -150			μА

NOTE: EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

- 3. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.3 V to -2.2 V.
- 4. All loading with 50 ohms to V<sub>CC</sub>-2.0 volts.
- 5. Not recommended for single ended operation when using an EP16F to drive another EP16F. V<sub>OL</sub> has reduced output swing and may not meet the V<sub>IL</sub> specification over temperature.
- V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

## DC CHARACTERISTICS, PECL $V_{CC} = 5.0 \text{ V}$ , $V_{EE} = 0 \text{ V}$ (Note 7.)

				-40°C			25°C			85°C		
Symbol	Characteristic		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
IEE	Power Supply Current		23	28	35	25	31	38	26	33	40	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 8.)	3	3855	3980	4105	3855	3980	4105	3855	3980	4105	mV
V <sub>OL</sub>	Output LOW Voltage (Note 8.)	3	3275	3390	3475	3275	3390	3475	3275	3390	3475	mV
V <sub>IH</sub>	Input HIGH Voltage (Single Ended)	3	3775		4120	3775		4120	3775		4120	mV
V <sub>IL</sub>	Input LOW Voltage (Single Ended) (Note 9.)	3	3190		3375	3190		3375	3190		3375	mV
V <sub>BB</sub>	Output Voltage Reference	3	3475	3575	3675	3475	3575	3675	3475	3575	3675	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential) (Note 10.)		2.0		5.0	2.0		5.0	2.0		5.0	V
I <sub>IH</sub>	Input HIGH Current				150			150			150	μΑ
I <sub>IL</sub>			0.5 -150			0.5 -150			0.5 -150			μΑ

NOTE: EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

- 7. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +2.0 V to -0.5 V.
- 8. All loading with 50 ohms to  $V_{CC}$ –2.0 volts.
- 9. Not recommended for single ended operation when using an EP16F to drive another EP16F. V<sub>OL</sub> has reduced output swing and may not meet the V<sub>IL</sub> specification over temperature.
- 10. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

DC CHARACTERISTICS, NECL  $V_{CC} = 0V$ ;  $V_{EE} = -5.5V$  to -3.0V (Note 11.)

		-40°C		25°C							
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
IEE	Power Supply Current	23	28	35	25	31	38	26	33	40	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 12.)	-1145	-1020	-895	-1145	-1020	-895	-1145	-1020	-895	mV
V <sub>OL</sub>	Output LOW Voltage (Note 12.)	-1725	-1610	-1525	-1725	-1610	-1525	-1725	-1610	-1525	mV
V <sub>IH</sub>	Input HIGH Voltage (Single Ended)	-1225		-880	-1225		-880	-1225		-880	mV
V <sub>IL</sub>	Input LOW Voltage (Single Ended) (Note 13.)	-1810		-1625	-1810		-1625	-1810		-1625	mV
V <sub>BB</sub>	Output Voltage Reference	-1525	-1425	-1325	-1525	-1425	-1325	-1525	-1425	-1325	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential) (Note 14.)	V <sub>EE</sub>	+2.0	0.0	V <sub>EE</sub>	+2.0	0.0	V <sub>EE</sub>	+2.0	0.0	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current DDD	0.5 -150			0.5 -150			0.5 -150			μΑ

NOTE: EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

AC CHARACTERISTICS  $V_{CC} = 0V$ ;  $V_{EE} = -3.0V$  to -5.5V or  $V_{CC} = 3.0V$  to 5.5V;  $V_{EE} = 0V$  (Note 15.)

		–40°C		25°C		85°C					
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>max</sub>	Maximum Toggle Frequency (See Figure 2. F <sub>max</sub> /JITTER)		> 4			> 4			> 4		GHz
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay to Output Differential	170	210	250	180	220	260	200	250	300	ps
t <sub>SKEW</sub>	Duty Cycle Skew		5.0	20		5.0	20		5.0	20	ps
<sup>†</sup> JITTER	Cycle–to–Cycle Jitter (RMS) (See Figure 2. F <sub>max</sub> /JITTER)		0.2	< 1		0.2	< 1		0.2	< 1	ps
$V_{PP}$	Input Voltage Swing (Differential)	150	800	1200	150	800	1200	150	800	1200	mV
t <sub>r</sub> t <sub>f</sub>	Output Rise/Fall Times Q (20% – 80%)	70	85	110	80	100	120	90	110	130	ps

<sup>15.</sup> Measured using a 750 mV source, 50% duty cycle clock source. All loading with 50 ohms to  $V_{CC}$ -2.0 V.

<sup>11.</sup> Input and output parameters vary 1:1 with V<sub>CC</sub>.

12. All loading with 50 ohms to V<sub>CC</sub>–2.0 volts.

13. Not recommended for single ended operation when using an EP16F to drive another EP16F. V<sub>OL</sub> has reduced output swing and may not meet the V<sub>IL</sub> specification over temperature.

<sup>14.</sup> V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

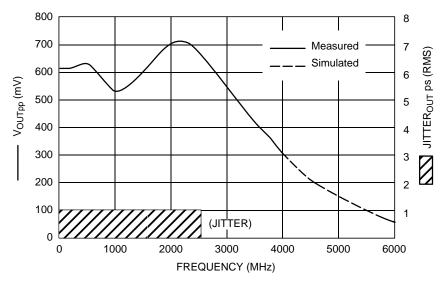


Figure 2. F<sub>max/JITTER</sub>

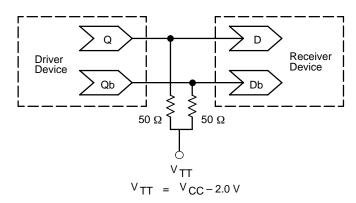


Figure 3. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020 – Termination of ECL Logic Devices.)

## **Resource Reference of Application Notes**

AN1404 – ECLinPS Circuit Performance at Non–Standard V<sub>IH</sub> Levels

AN1405 – ECL Clock Distribution Techniques

AN1406 – Designing with PECL (ECL at +5.0 V)

AN1504 — Metastability and the ECLinPS Family

AN1568 – Interfacing Between LVDS and ECL

AN1650 – Using Wire-OR Ties in ECLinPS Designs

AN1672 – The ECL Translator Guide

AND8001 - Odd Number Counters Design

AND8002 - Marking and Date Codes

AND8009 – ECLinPS Plus Spice I/O Model Kit

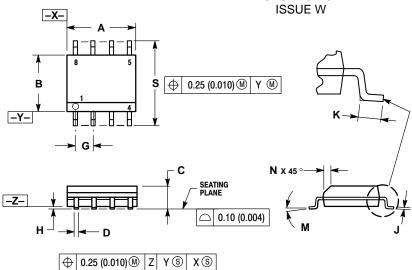
AND8020 – Termination of ECL Logic Devices

AND8033 — Method for AC Data Measurement

For an updated list of Application Notes, please see our website at http://onsemi.com.

#### **PACKAGE DIMENSIONS**

## SO-8 **D SUFFIX** PLASTIC SOIC PACKAGE CASE 751-07



#### NOTES:

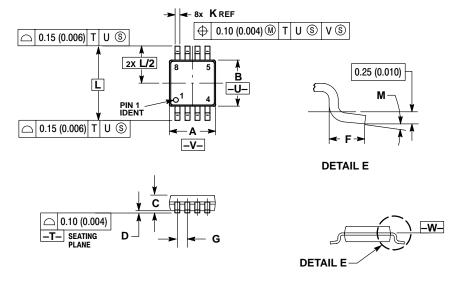
- DIMENSIONING AND TOLERANCING PER ANSI
  Y14.5M. 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A AND B DO NOT INCLUDE MOLD
- PROTRUSION.

  MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER
- SIDE.

  DIMENSION D DOES NOT INCLUDE DAMBAR
  PROTRUSION. ALLOWABLE DAMBAR
  PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN
  EXCESS OF THE D DIMENSION AT MAXIMUM
  MATERIAL CONDITION.

	MILLIN	MILLIMETERS INC			
DIM	MIN	MAX	MIN	MAX	
Α	4.80	5.00	0.189	0.197	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.053	0.069	
D	0.33	0.51	0.013	0.020	
G	1.27	7 BSC	0.05	0 BSC	
Н	0.10	0.25	0.004	0.010	
J	0.19	0.25	0.007	0.010	
K	0.40	1.27	0.016	0.050	
M	0 °	8 °	0 °	8 °	
N	0.25	0.50	0.010	0.020	
S	5.80	6.20	0.228	0.244	

## TSSOP-8 **DT SUFFIX** PLASTIC TSSOP PACKAGE CASE 948R-02 ISSUE A



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH.
  PROTRUSIONS OR GATE BURRS. MOLD FLASH
  OR GATE BURRS SHALL NOT EXCEED 0.15
- (0.006) PER SIDE.

  4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

  5. TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY.

  6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	2.90	3.10	0.114	0.122
В	2.90	3.10	0.114	0.122
С	0.80	1.10	0.031	0.043
D	0.05 0.15		0.002	0.006
F	0.40	0.70	0.016	0.028
G	0.65	BSC	0.026	BSC
K	0.25	0.40	0.010	0.016
L	4.90	BSC	0.193	BSC
M	0°	6 °	0°	6°



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